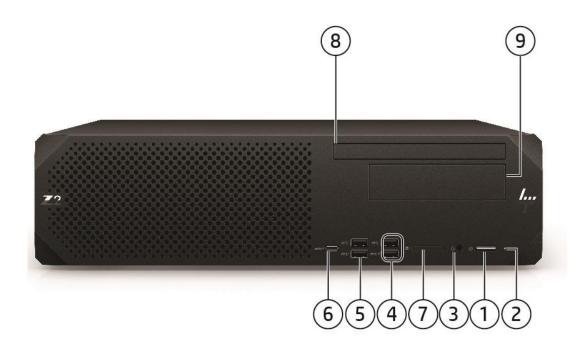
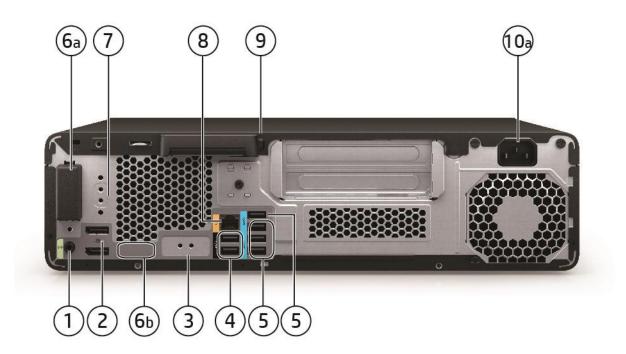
## **HP Z2 G9 SFF Workstation Desktop PC**



#### Front View

- 1. Power button
- 2. HDD Activity LED & Power button LED
- 3. Universal audio jack (with CTIA & OMTP headset support)
- 4. (2) Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge port supports up to 5V/2.1A)
- 5. (2) Type-A SuperSpeed USB 10Gbps signaling rate port
- 6. (1) Type-C® SuperSpeed USB 20Gbps signaling rate port (charge supports up to 5V/3A)
- 7. Media Card Reader 4.0 (optional)
- 8. Slim ODD bay
- 9. Shared internal/external 3.5" bay





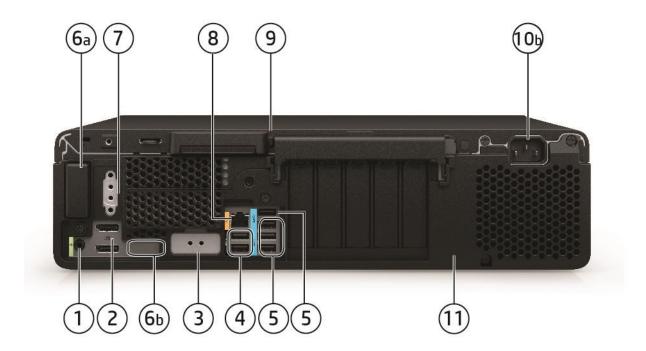
#### Rear View (Riser Chassis)

- 1. Audio line out
- 2. (2) DisplayPort 1.4
- 3. Flex I/O module: choose one from the following:
  (1) DisplayPort 1.4, (1) HDMI 2.0b, (1) VGA, 1 Dual
  SuperSpeed USB Type-A 5Gbps signaling rate, 1
  SuperSpeed USB Type-C® 10Gbps signaling rate (Power
  Delivery 15W, Alt Mode DisplayPort), (1) 2nd 1GbE LAN, (1)
  1Gbps Fiber LC LAN, (1) Thunderbolt 3\*\* with SuperSpeed
  USB4 Type-C® 40Gbps signaling rate (cabled to PCIe AIC)
- 5. (3) Type A SuperSpeed USB 5Gbps signaling rate port (1) Hi-Speed USB 480Mbps signaling rate port
- 6. WLAN Antenna (optional)
  - a. Internal
  - b. External
- 7. 2nd serial port (optional)
- 8. RJ-45
- 9. Release latch
- 10. Power connector
  - a. 550W PSU (full height graphic/chassis)

4. (2) Hi-Speed USB 480Mbps signaling rate port

Note: Onboard Display support DP1.4/HBR2. Flex I/O module Display support DP1.4/HBR3. Resolution all support up to 5120x3200 24bpp @60Hz.

\*\*Thunderbolt only support on PCI-E slot3.



#### Rear View (Standard Chassis)

- 1. Audio line out
- 2. (2) DisplayPort 1.4
- Flex I/O module: choose one from the following:

   (1) DisplayPort 1.4, (1) HDMI 2.0b, (1) VGA, 1 Dual
   SuperSpeed USB Type-A 5Gbps signaling rate, 1
   SuperSpeed USB Type-C® 10Gbps signaling rate (Power Delivery 15W, Alt Mode DisplayPort), (1) 2nd 1GbE LAN, (1)
   1Gbps Fiber LC LAN, (1) Thunderbolt 3\*\* with SuperSpeed USB4 Type-C® 40Gbps signaling rate (cabled to PCIe AIC)
- 4. (2) Hi-Speed USB 480Mbps signaling rate port

- 5. (3) Type A SuperSpeed USB 5Gbps signaling rate port (1) Hi-Speed USB 480Mbps signaling rate port
- 6. WLAN Antenna (optional)
  - a. Internal
  - b. External
- 7. 2nd serial port (optional)
- 8. RJ-45
- 9. Release latch
- 10. Power connector
  - b. 260W/450W PSU (low-profile graphic/chassis)
- 11. GS Mark Cover

Note: Onboard Display support DP1.4/HBR2. Flex I/O module Display support DP1.4/HBR3. Resolution all support up to 5120x3200 24bpp @60Hz.

\*\*Thunderbolt only support on PCI-E slot3.

# Form Factor Operating Systems

**Small Form Factor** 

#### Preinstalled:

- Windows 11 Pro HP recommends Windows 11 Pro<sup>2</sup>
- Windows 11 Home HP recommends Windows 11 Pro<sup>2</sup>
- Windows 10 Pro (available through downgrade rights from Windows 11 Pro) 1,2,3
- Linux®-ready⁵
- Ubuntu 20.04 LTS<sup>4</sup>

#### Web-supported only:

Windows 10 Enterprise 64<sup>2</sup>

#### **Supported Version:**

 HP tested Windows 10, versions 20H2, 21H1 and 21H2 on this platform. For testing information on newer versions of Windows 10, please see: https://support.hp.com/document/c05195282.

<sup>1</sup> Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).

<sup>2</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.

<sup>3</sup>This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

<sup>4</sup> Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

<sup>5</sup>For detailed Linux® OS/hardware support information, see:

http://www.hp.com/support/linux\_hardware\_matrix

**NOTE:** Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

#### **Processors\***

Name	Cores	Clock Speed (GHz)	Threads	Cache (MB)	Memory Speed (MT/s)	Hyper- Threadin g	Integrated Graphics		Featuring Intel® vPro® Technology	16GB Intel® Optane™ memory²	TDP (W)
Intel® Core™ i9-12900K Processor	16	3.2	24	30	4800	Υ	Intel® UHD Graphics 770	5.2	Y	N	125
Intel® Core™ i9-12900 Processor	16	2.1	24	30	4800	Υ	Intel® UHD Graphics 770	5.1	Y	N	65
Intel® Core™ i7-12700K Processor	12	3.6	20	25	4800	Υ	Intel® UHD Graphics 770	5.0	Y	N	125



#### Overview

Intel® Core™ i7-12700 Processor	12	2.1	20	25	4800	Υ	Intel® UHD Graphics 770	4.9	Y	N	65
Intel® Core™ i5-12600K Processor	10	3.7	16	20	4800	Υ	Intel® UHD Graphics 770	4.9	Y	N	125
Intel® Core™ i5-12600 processor	6	3.3	12	18	4800	Υ	Intel® UHD Graphics 770	4.8	Y	N	65
Intel® Core™ i5-12500 processor	6	3.0	12	18	4800	Υ	Intel® UHD Graphics 770	4.6	Y	N	65
Intel® Core™ i5-12400 processor	6	2.5	12	18	4800	Υ	Intel® UHD Graphics 730	4.4	N/A	N	65
Intel® Core™ i3-12300 processor	4	3.5	8	12	4800	Υ	Intel® UHD Graphics 730	4.4	N/A	N	60
Intel® Core™ i3-12100 processor	4	3.3	8	12	4800	Υ	Intel® UHD Graphics 730	4.3	N/A	N	60

<sup>1</sup> Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

<sup>2</sup> Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

<sup>3</sup> Intel Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

<sup>4</sup> Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro

**Note:** ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700K, Intel® Core™ i7-12700, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

Color Black

**Convertibility** The SFF can either be placed flat on the desktop or made to stand on the desk with the optional tower

stand.

**Expansion Slots** Slot 1: (see system board section PCIe Gen4 x16

for more details)<sup>1</sup> Slot 2:

PCIe Gen3 x4 Slot 3:

PCIe Gen3 x4 - with x16 Connector

Slot 4: PCIe Gen3 x1

**Expansion Bays** (see

(1) Shared internal/external 3.5" bay

storage section for more

(1) Internal 3.5" bay

details)

(1) Internal 3.5" bay (optional)(1) Dedicated 9.5mm slim optical disk drive bay

Front I/O 2 Type-A SuperSpeed USB 10Gbps signaling rate port (1 charge port supports up to 5V/2.1A), 2 Type-A

SuperSpeed USB 10Gbps signaling rate port, 1 Type-C SuperSpeed® USB 20Gbps signaling rate port

(charge supports up to 5V/3A), 1 SD card reader (optional), 1 universal audio jack

Internal I/O [5] (1) Hi-Speed USB 480Mbps signaling rate header for SD card reader

(1) serial port available with header (1) serial and PS/2 available with header

Rear I/O 2 DisplayPort 1.4 [3], 1 Audio Line out, 1 RJ-45, 3 Hi-Speed USB 480Mbps signaling rate port, 3 Type-A

SuperSpeed USB 5Gbps signaling rate port, 1 serial (optional), 1 Flex I/O port (VGA, HDMI 2.0b, DisplayPort 1.4, Type-C® SuperSpeed USB 10Gbps signaling rate port (Power Delivery 15W, Alt Mode Display Port), Dual Tye-A SuperSpeed USB 5Gbps signaling rate port, 2nd 1GbE LAN, 1 Thunderbolt 3 with SuperSpeed USB4 Type-C® 40Gbps signaling rate (cabled to PCIe AIC), 1 1Gbps Fiber LC NIC

**Optional I/O** Flex IO\* – choose one of the following options: 1 DisplayPort™ 1.4, 1 HDMI 2.0b, 1 VGA,1 2nd 1GbE

LAN, 1 1Gbps Fiber LC NIC, 1 Dual SuperSpeed USB Type-A 5Gbps signaling rate,1 SuperSpeed USB Type-C® 10Gbps signaling rate (15W USB Power Delivery, Alt Mode DisplayPort™) 1 Thunderbolt™ 3 with SuperSpeed USB4 Type-C® 40Gbps signaling rate (cabled to PCIe® AIC); Front - 1 SD card reader;

Rear – 1 serial; 1 SD 4.0 card reader

\* Flex IO port and one PCIe slot will be occupied when Thunderbolt is installed.

Thunderbolt will be available in Q2, 2022 (1st refresh).

**Interfaces Supported** 

SD card reader (optional)

On-board RAID Support SATA and NVME RAID 0 Striped Array

SATA RAID and NVME RAID 1 Mirror Array

**Chassis Dimensions** 

(H x W x D)

H: 3.95" [100mm] W: 15.1" [384mm]

D: 12.1" [308mm] (Standard desktop orientation)

**Packaged Dimensions** H: 8.98" (228mm)

W: 15.71" (399mm) D: 19.65" (499mm)

**Weight** Exact weights depend upon configuration (System weight only).

Starting at 5.0kg (11.1lbs.)

**Temperature** Operating: 5° to 35° C (40° to 95° F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1°C (1.8°F) for

every 305 m (1,000 feet) increase in elevation Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

**Humidity** Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude (non-

pressurized)

Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)
Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Temperature for details.

**Power Supply** 550W wide-ranging, active Power Factor Correction, 92% Efficiency. 450W wide-ranging, active Power

Factor Correction, 90% Efficiency. 260W wide-ranging, active Power Factor Correction, 92% Efficiency. NOTE: The Power Supply Efficiency Report for the 450W 90% Efficiency and 260W 92% Efficiency

Power Supply may be found at the following links:

550W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

450W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2



#### Overview

260W PSU:

https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2

**Backup Devices** For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup

System offerings, please visit http://www.hp.com/go/connect

**Chipset** Intel® W680 chipset

Memory 4 DIMM slots, supporting up to 128GB ECC/non-ECC, DDR5 4800 MT/s speed depending on the system

configuration



## **Supported Components**

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	12th Generation Intel Core Processors <sup>1</sup>				
	Intel® Core™ i9-12900K Processor	Υ	N		
	Intel® Core™ i9-12900 Processor	Υ	N		
	Intel® Core™ i7-12700K Processor	Υ	N		
	Intel® Core™ i7-12700 Processor	Υ	N		
	Intel® Core™ i5-12600K Processor	Υ	N		
	Intel® Core™ i5-12600 processor	Υ	N		
	Intel® Core™ i5-12500 processor	Υ	N		
	Intel® Core™ i5-12400 processor	Υ	N		1
	Intel® Core™ i3-12300 processor	Υ	N		1
	Intel® Core™ i3-12100 processor	Υ	N		1

**Note:** ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700K, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

**NOTE 1:** These processors support only non-ECC memory

**NOTE 2:** No iGfx. A discrete graphics card must be purchased at the same time.

Storage / Hard Drives*		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	SATA Hard Drives				
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA	
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA	
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	WOR10AA	
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	2Z274AA	
	4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	K4T76AA	
	8TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)	Υ	Υ	2Z273AA	
	500GB SATA 7.2K SED SFF HDD	Υ	Υ	D8N29AA	
	PCIe Solid State Drives				
	HP ZTurbo 512GB PCIe-Gen 4x4 TLC Z2 SSDKit	Υ	Υ	201G0AA	
	HP ZTurbo 512GB PCIe-Gen 4x4 SED Z2 SSDKit	Υ	Υ	201F9AA	
	HP ZTurbo 1TB PCIe-Gen 4x4 TLC Z2 SSDKit	Υ	Υ	201F5AA	
	HP ZTurbo 2TB PCIe-Gen 4x4 TLC Z2 SSDKit	Υ	Υ	201F8AA	
	HP Z Turbo Drive 1TB 2280 PCIe-4x4 SED 0PAL2 TLC Z2 Kit SSD	Υ	Υ	223A3AA	
	HP Z Turbo Drive 2TB 2280 PCIe-4x4 SED OPAL2 TLC Z2 Kit SSD	Υ	Υ	223A4AA	
	Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z2 Kit SSD	Υ	Υ	5S498AA	
	HP 256GB PCIe NVME TLC M.2 Z2 G9 TWR/SFF SSD	Υ	Υ		
	HP 500GB PCIe NVME TLC M.2 Z2 G9 TWR/SFF SSD	Υ	Υ		



# **Supported Components**

HP 1TB PCIe NVME TLC M.2 Z2 G9 TWR/SFF SSD	Y	γ	
HP 256GB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD	У	Y	4M9Z1AA
THE 250GB 2280 PCIE-4X4 INVINE VALUE M.2 22 KIL 55D	Y	Y	4M9ZTAA
HP 512GB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD	Υ	Υ	4M9Z2AA
HP 1TB 2280 PCIe-4x4 NVMe Value M.2 Z2 Kit SSD	Υ	Υ	4M9Z3AA
HP Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 Z2 Kit SSD	Υ	Υ	5S492AA
HP Z Turbo 2TB PCIe-4x4 TLC SSD Module	Υ	Υ	38T75AA
HP Z Turbo 1TB 2280 PCIe-4x4 SED 0PAL2 TLC M.2 SSD Module	Υ	Υ	38T76AA
HP Z Turbo 1TB PCIe-4x4 TLC SSD Module	Υ	Υ	38T77AA
HP Z Turbo 2TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module	Υ	Υ	38T79AA
HP Z Turbo 512GB PCIe-4x4 TLC SSD Module	Υ	Υ	38T80AA
HP Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD Module	Υ	Υ	38T81AA
HP Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 SSD Module	Υ	Υ	5S496AA
HP Z Turbo 4TB 2280 PCIe-4x4 SED 0PAL2 TLC M.2 SSD Module	Υ	Υ	5S497AA

<sup>\*</sup>For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	 Supported # of cards
	Graphics Cable Adapters				
	HP DisplayPort To HDMI True 4k Adapter	Υ	Υ	2JA63AA	
	HP Single miniDP-to-DP Adapter Cable	Υ	Υ	2MY05AA	
	HP DisplayPort To DVI-D Adapter	Υ	Υ	FH973AA/A6	
	HP DisplayPort To VGA Adapter	Υ	Υ	AS615AA/AT	
	HP DisplayPort To VGA Adapter	Υ	Υ	AS615A6	
	HP DisplayPort To VGA Adapter	Υ	Υ	F7W97AA	
	HP USB-C to DisplayPort Adapter	Υ	Υ	4SH08AA	
	HP USB-C to HDMI Adapter	Υ	Υ	4SH07AA	
	HP USB-C to VGA Adapter	Υ	Υ	4SH06AA	
	Entry 3D				
	NVIDIA® T400 2 GB Graphics <sup>1</sup>	Υ	Υ	340K8AA	1
	NVIDIA® T400 4 GB Graphics	Υ	Υ	5Z7EOAA/AT	2
	NVIDIA® T600 4 GB Graphics <sup>1</sup>	Υ	Υ	340K9AA	2
	NVIDIA® T1000 4 GB MXM Graphics	Υ	Υ	20X22AA/AT	1
	Mid-range 3D				
	NVIDIA® T1000 8 GB Graphics	Υ	Υ	5Z7D8AA/AT	1
	NVIDIA® RTX™ A2000 12GB Graphics*	Υ	Υ	5Z7D9AA/AT	1
	AMD Radeon™ Pro W6600 Graphics (8GB GDDR6 dedicated) *	Υ	Υ	340K5AA	1
	High-end 3D				



### **Supported Components**

AMD Radeon™ RX 6700 XT Graphics (12 GB Y N 2 DDR6 dedicated) \* N 1 2 NVIDIA® RTX™ A4000 16 GB Graphics\* Y Y 20X24AA/AT 2 1

**Note 1:** NVIDIA® T400 (2 GB GDDR6 dedicated) and NVIDIA® T600 (4 GB GDDR6 dedicated) may go End of Life in late 2022.

**Note 2:** Full Height Graphics (eg. NV A4000, AMD 6700) are only supported by Full Height Chassis/550W PSU)

<sup>\*</sup> Requires 700W chassis.

Memory		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 8GB (1x8GB) DDR5-4800 UDIMM NECC	Υ	Υ	4M9X9AA	
	HP 16GB (1x16GB) DDR5-4800 UDIMM NECC	Υ	Υ	4M9Y0AA	
	HP 16GB (1x16GB) DDR5-4800 UDIMM ECC	Υ	Υ	4M9Y1AA	1
	HP 32GB (1x32GB) DDR5-4800 UDIMM NECC	Υ	Υ	4M9Y2AA	
	HP 32GB (1x32GB) DDR5- 4800 UDIMM ECC	Υ	Υ	4M9Y3AA	1

**NOTE 1:** ECC memory is supported on the following: Intel® Core™ i9-12900K, Intel® Core™ i9-12900, Intel® Core™ i7-12700K, Intel® Core™ i7-12700K, Intel® Core™ i5-12600K, Intel® Core™ i5-12600 and Intel® Core™ i5-12500 processors

**NOTE 2:** Two channels of DDR5 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

**NOTE 3:** Though the memory modules can run up to 4800MHz, the current platform will only be able to support the maximum memory speed of 4400MHz.

The system speed will be determined by a number of key factors:

Module Configuration	Description of configuration	Max Memory Speed (Actual Memory speed is dependent on CPU)
Single DIMM per channel	Configurations that contain only one or two DIMM modules with DIMMs only in the black slots	4400MHz
Two single ranked DIMMs in a channel	Configurations with 3 or 4 single ranked DIMMs (8GB and 16GB) installed in a system	4000MHz
Two dual ranked DIMMs in a channel	Configurations with 3 or 4 dual ranked DIMMs (32GB) installed in a system	3600MHz

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number
	HP DP25 Removable 2.5" HDD Frame/Carrier	Υ	Υ	W3J84AA
	HP DP25 2.5 in HDD Spare Carrier	Υ	Υ	W3J85AA
	HP Z2 SFF DVD-Writer 9.5mm Slim ODD	Υ	Υ	4L5J9AA
	HP Z2 SFF DVD-ROM 9.5mm Slim ODD	Υ	Υ	4L5J8AA
	HP CRU QX328 3.5 in Front Removable Frame/Carrier	Υ	Υ	4N012AA
	HP CRU SHIPS M.2 2TB Storage Module	Υ	Υ	56Q87AA
	HP CRU SHIPS M.2 1TB Storage Module	Υ	Υ	56Q88AA



### **Supported Components**

HP CRU SHIPS M.2 512GB Storage Module Y Y 56Q89AA
HP CRU SHIPS M.2 Spare Carrier Y Y 633X9AA

NOTE: With Blu-Ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this Desktop PC.

NOTE: Duplication of copyrighted material is strictly prohibited. Actual speeds may vary. Double Layer media compatibility will widely vary with some home DVD players and DVD-ROM drives. Note that DVD-RAM cannot read or write to 2.6GB Single Sided/5.2 Double Sided-Version 1.0 Media.

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	Integrated Intel® I219LM PCIe GbE Controller (Intel® vPro® with Intel® AMT 16.0)	Υ	N	
	HP 1GbE LAN Flex Port 2020	Υ	Υ	141J6AA/AT
	HP Flex 1GbE Fiber LC Single Port	Υ	Υ	20J15AA
	NVIDIA Mellanox ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC <sup>1</sup>	Υ	Υ	436M8AA
	NVIDIA Mellanox 10GbE SFP+ SR Transceiver <sup>1</sup>	Υ	Υ	4M9X7AA
	Intel Ethernet I350-T4 4-Port 1Gb NIC*	N	Υ	W8X25AA
	Intel X550 10GBASE-T Dual Port NIC	Υ	Υ	1QL46AA
	NVIDIA Mellanox 25GbE SFP28 Transceiver <sup>1</sup>	Υ	Υ	436N4AA
	Intel Ethernet Network Adapter I225-T1	Υ	Υ	406L9AA
	Intel Ethernet I350-T2 2-Port 1Gb NIC	Υ	Υ	V4A91AA
	Intel Wi-Fi 6E AX211 BT 5.2 M.2 non-vPro <sup>2,**</sup>	Υ	N	

<sup>\*</sup>Intel I350-T4 4-port GbE NIC is an After Market Option only.

**NOTE 1**: The integrated network connection is required to support Intel® vPro® Technology.

**NOTE 2**: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

**NOTE 3**: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	HP Keyed Cable Lock	N	Υ	T1A62AA
	HP Master Keyed Cable Lock 10mm	N	Υ	T1A63AA
	HP Business PC Security Lock V3 Kit	N	Υ	3XJ17AA



<sup>&</sup>lt;sup>1</sup> Available in Q2, 2022

<sup>&</sup>lt;sup>2</sup> Intel AX211 with Internal antenna support WIFI 6

<sup>&</sup>lt;sup>2</sup> Intel AX211 with external antenna support WIFI 6E

<sup>\*\*</sup>Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

# **Supported Components**

Supported Comp				
Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP 320K Wired Keyboard	Υ	Υ	9SR37AA
	HP 455 Programmable Wireless Keyboard	Υ	Υ	4R177AA
	HP 975 USB+BT Dual-Mode Wireless Keyboard	Υ	Υ	3Z726AA
	HP 655 Wireless Keyboard and Mouse Combo	Υ	Υ	4R009AA
	HP 125 Wired Keyboard	Υ	Υ	266C9AA
	HP Wired Desktop 320MK Mouse and Keyboard	Υ	Υ	9SR36AA
	HP Wired 320M Mouse	Υ	Υ	9VA80AA
	HP 128 Laser Wired Mouse	Υ	Υ	265D9AA
	HP 125 Wired Mouse	Υ	Υ	265A9AA
	HP Creator 935 Black Wireless Mouse	Υ	Υ	1DOK8AA
	HyperX Cloud MIX Wireless GAM HEADSET	N	Υ	4P5K9AA
	HyperX Cloud Core BLK GAM HEADSET	N	Υ	4P4F2AA
	HyperX Cloud Flight - Wireless Gaming Headset (Black-Red) (HX-HSCF-BK/AM)	N	Υ	4P5L4AA
	HyperX Cloud Stinger Core GAM HEADSET PC	N	Υ	4P4F4AA
	HyperX SoloCast - USB Microphone (Black) (HMIS1X-XX-BK/G)	N	Υ	4P5P8AA
	<b>Note:</b> Keyboard and Mouse are optional or add on features.			
Other Hardware		Factory		<b>Option Kit Part</b>
		Configured	Option Kit	Number
	HP Z2 Internal Serial Port and PS/2 Port	Υ	Υ	141K9AA/AT
	HP Z2 Power Cord Kit	Υ	Υ	1N1D5AA
	HP Z2 2nd serial port adapter	Υ	Υ	141K8AA/AT
	HP PCIe x1 Parallel Port Card	Υ	Υ	N1M40AA
	HP DP Flex Port 2020	Υ	Υ	141J7AA/AT
	HP 1GbE LAN Flex Port 2020	Υ	Υ	141J6AA/AT
	HP Flex 1GbE Fiber LC Single Port	Υ	Υ	20J15AA
	HP Dual USB-A 3.2 Gen1 Flex 2020	Υ	Υ	141J8AA/AT
	HP HDMI Flex Port	Υ	Υ	69D47AA/AT
	HP USB-C 3.2 Gen2 Alt Flex Port 2020	Υ	Υ	141K6AA/AT
	HP VGA Flex Port 2020	Υ	Υ	141K7AA/AT
	HP Z2 SFF Dust Filter	Υ	Υ	4N002AA
	HP Z2 SFF Dust Filter and bezel	Υ	Υ	4N003AA
	<sup>1</sup> Available in Q3, 2021			
Software		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Υ	N	1
	HP PC Hardware Diagnostics UEFI (Windows OS only)	Υ	N	2
	HP PC Hardware Diagnostics Windows		N	3
	HP Wolf Security	Υ	N	



**HP Notifications** 

**HP Desktop Support Utility** 

Υ

Ν

Ν

# **Supported Components**

HP Documentation	Υ	N	
HP Image Assistant	N	N	
HP Support Assistant	N	N	
HP Quick Drop	Υ	N	
myHP	Υ	N	
HP Easy Clean	Υ	N	
HP Smart Health	Υ	N	7
Kingsoft WPS Office	Υ	N	4
My Office	Υ	N	5
Adobe Substance 3D Collection Plan	N	Υ	6
WSL2/Ubuntu Data Science Stack	Υ	N	7

#### **Notes:**

- 1. Supports, and preinstalled with Windows 10 only. Also available as a free download from http://www.hp.com/go/performanceadvisor
- 2. Windows OS only
- 3. Not available in Russia
- 4. Only available in China
- 5. Only available in Russia
- 6. Not available in China
- 7. Optional Software

### Supported Components

#### **Operating Systems**

Windows 11 Pro - HP recommends Windows 11 Pro<sup>2</sup>
Windows 11 Home - HP recommends Windows 11 Pro<sup>2</sup>
Windows 10 Pro (available through downgrade rights from Windows 11 Pro) <sup>1,2,3</sup>
Linux®-ready<sup>5</sup>

Ubuntu 20.04 LTS<sup>4</sup>

- <sup>1</sup> Device comes with Windows 10 and a free Windows 11 upgrade or may be preloaded with Windows 11. Upgrade timing may vary by device. Features and app availability may vary by region. Certain features require specific hardware (see Windows 11 Specifications).
- <sup>2</sup> Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.windows.com">http://www.windows.com</a>.
- <sup>3</sup>This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.
- <sup>4</sup> Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

<sup>5</sup>For detailed Linux® OS/hardware support information, see: http://www.hp.com/support/linux\_hardware\_matrix

**NOTE:** Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



### Supported Components

#### **HP BIOS**

#### Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Z2 G9 SFF Workstation Desktop PC into the enterprise, such as PXE, remote recovery, remote configuration, remote control, and BIOS (F10) Setup support for 15 languages.
- Network firmware updates Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Class 3 UEFI specification version 2.7
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Workstation computers, including BIOS updates from within Windows (HP Firmware Update and Recovery), Capsule update, HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

#### Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent
  unauthorized changes to the system configuration. If the administrator password is not
  known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS
  Setup or under the OS.
- S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
  - -Power to expansion connectors / slots
  - -Most Wake events other than power buttons and WOL (Wake on LAN supported by embedded Lan controller under S4/S5 Maximum Power Saving Enabled)
  - -USB charging ports

#### HP Sure Start Gen7

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed
  and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while
  the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.



### **Supported Components**

 Audit enabled – System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating.

**NOTE:** HP Sure Start Gen7 is available on HP Workstation products equipped with Intel® 11th generation processors.

#### SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

#### Software

HP Support Assistant 14

**HP Image Assistant** 

**HP Desktop Support Utility** 

**HP Documentation** 

**HP Notifications** 

**HP PC Hardware Diagnostics UEFI** 

**HP PC Hardware Diagnostics Windows** 

HP Performance Advisor<sup>1</sup>

myHP

HP QuickDrop<sup>19</sup>

HP Easy Clean<sup>20</sup>

HP Smart Health<sup>21</sup>

WSL/Ubuntu Data Science Stack

**HP Privacy Settings** 

**Touchpoint Customizer for Commercial** 

#### **Manageability Features**

HP Driver Packs<sup>2</sup>

**HP UWP Pack** 

HP System Software Manager (SSM)

HP Manageability Integration Kit Gen43

HP Smart Support⁵

**HP Client Catalog (download)** 

HP Image Assistant (download)

**HP Cloud Recovery** 

HP Client Management Script Library (download)

HP BIOSphere Gen6 13

#### **Client Security Software**

HP Client Security Suite Gen74 including: (including Credential Manager, HP Password Manager6, HP Spare Key)

**HP Power On Authentication** 

Microsoft Defender<sup>7</sup>

#### **Security Management**

HP Secure Erase 16

HP Wolf Pro Security Edition (optional) 18

HP Wolf Security for Business<sup>22</sup> Includes:

HP Sure Click<sup>11</sup>

HP Sure Sense<sup>12</sup>

HP Sure Run Gen59

HP Sure Recover Gen4 10

HP Sure Start Gen78

**HP Tamper Lock** 

HP Sure Admin 17



### Supported Components

HP Client Security Manager Gen 74

- <sup>1</sup> HP Performance Advisor Software HP Performance Advisor is ready to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: http://hp.com/PerformanceAdvisor
- <sup>2</sup> HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- <sup>3</sup> HP Manageability Integration Kit can be downloaded from http://www8.hp.com/us/en/ads/clientmanagement/overview.html
- <sup>4</sup> HP Client Security Manager Gen7 requires Windows and is available on the select HP PCs.
- <sup>5</sup> HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.
- <sup>6</sup> HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- <sup>7</sup> Microsoft Defender Opt in and internet connection required for updates.
- <sup>8</sup> HP Sure Start Gen 7 is available on select HP PCs and workstations. See product specifications for availability.
- <sup>9</sup> HP Sure Run Gen5 is available on select Windows 11 based HP Pro, Elite and Workstation PCs with select Intel® or AMD processors
- <sup>10</sup> HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module
- 11 HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A\_SureClick for complete details.
- <sup>12</sup> HP Sure Sense requires Windows 11 Pro or Enterprise and supports Microsoft Internet Explorer, Google Chrome™, and Chromium™. Supported attachments include Microsoft Office (Word, Excel, PowerPoint) and PDF files in read only mode, when Microsoft Office or Adobe Acrobat are installed.
- <sup>13</sup> HP BIOSphere Gen6 features may vary depending on the platform and configurations.
- <sup>14</sup> HP Support Assistant requires Windows and Internet access.
- <sup>16</sup> Secure Erase For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane.
- <sup>17</sup> HP Sure Admin requires Windows 11, HP BIOS, HP Manageability Integration Kit from
- http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.
- 18 HP Wolf Pro Security Edition is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-
- en/document/ish\_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.
- <sup>19</sup> HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.
- <sup>20</sup> HP Easy Clean requires Windows 10 RS3 and higher and will disable the keyboard, touchscreen, and clickpad only. Ports are not disabled. See user guide for cleaning instructions.
- <sup>21</sup> HP Smart Health automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services;



## **Supported Components**

or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

<sup>22</sup> HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features



# System Technical Specifications

**System Board** 

**System Board Form** 

Customized PCB 231.04 x 301.24 mm (9.213X11.86inches)

**Factor** 

Processor Socket Single LGA-1700

DMI **CPU Bus Speed** 

Chipset Intel® PCH W680

Super I/O Controller

Nuvoton SIO21

Memory Expansion Slots 4 DDR5 memory slots

Memory Type Supported DDR5, UDIMM (Unbuffered), ECC& non-ECC

**Memory Modes** Non-Interleaved for single channel. Interleaved when both channels are populated.

Memory Speed Supported 3600MT/s to 4400MT/s DDR5, dependent on memory configuration<sup>1</sup>

Though the memory modules can run up to 4800MHz, the current platform will only be able to support the maximum memory speed of 4400MHz.

The system speed will be determined by a number of key factors:

Module **Description of configuration Max Memory Speed (Actual Memory** Configuration speed is dependent on CPU)

4000MHz

Single DIMM per Configurations that contain only one or two 4400MHz channel

DIMM modules with DIMMs only in the black slots

Configurations with 3 or 4 single ranked DIMMs Two single ranked

DIMMs in a channel (8GB and 16GB) installed in a system

Two dual ranked Configurations with 3 or 4 dual ranked DIMMs 3600MHz

DIMMs in a channel (32GB) installed in a system

**Memory Protection** ECC available on data

128GB **Maximum Memory** 

**Memory Configuration** (Supported)

8GB, 16GB and 32GB non-ECC, 16GB and 32GB ECC unbuffered DIMMs are supported. ECC and non-ECC memory DIMMs cannot be mixed in the same system

**NOTE**: Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 11 Professional 64 bit, Red Hat Linux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.

**PCI Express Connectors** (1) PCI Express Gen4 slot x16 mechanical/ x16 electrical (Low-Profile)

(1) PCI Express Gen3 slot x4 mechanical/ x4 electrical (Low-Profile, open-ended)

(1) PCI Express Gen3 slot x16 mechanical/ x4 electrical (Low-Profile)

(1) PCI Express Gen3 slot x1 mechanical/ x1 electrical (Low-Profile, open-ended)

(1) M.2 2280 Storage (PCIe Gen4 x4)

(1) M.2 2280 Storage (PCIe Gen4 x4)

(1) M.2 2280 Storage (PCIe Gen4 x4)

(1) M.2 2230 WLAN (PCIe Gen3 x1+ Intel CNVi)



### System Technical Specifications

NOTE: The PCIe Gen 4 x16 slot is meant for HP qualified cards, configured or after market. HP does not provide warranty support for 3rd party cards.

**Supported Interfaces** 

**SATA** 

Integrated (4) Serial ATA interfaces (6Gb/s SATA).

**Serial Attached SCSI** 

**Integrated Graphics** 

None

Intel® UHD Graphics 730 (on Core i5-12400/i3-12300/i3-12100) processors); Intel® UHD Graphics 770 (on Core i5/i7/i9 processors); Based on Unified Memory Architecture (UMA) - a region of system

memory is reserved and dedicated to the graphics display.

Support for Microsoft DirectX 12, OpenGL 4.6 and OpenCL 3.0 on Intel®

UHD Graphics 730/770;

Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics display.

2 DP 1.4 graphics ports integrated in motherboard; Supports up to three

simultaneous displays across DisplayPort\*/HDMI\*/DVI outputs.

Max. resolution supported on onboard DP 1.4/HBR2 ports: 4096x2304 @

60Hz, 24bpp

Max. resolution supported on FlexIO DP 1.4/HBR3 port: 5120x3200

@60Hz, 24bpp

**Network Controller** Integrated Ethernet PHY Connection I219LM. Management capabilities:

WOL, PXE 2.1 and AMT 16

External SATA (eSATA) None IDE connector None Floppy connector None

Serial 1 internal header (requires optional Serial Port and PS/2 Combo Kit with

PCIe bracket)

**2nd Serial** 1 internal header (requires optional Serial Port Adapter Kit)

Front 2 Type-A SuperSpeed USB 10Gbps signaling rate port (charge supports up

to 5V/2.1A);

2 Type-A SuperSpeed USB 10Gbps signaling rate port; 1 Type-C<sup>®</sup> SuperSpeed USB 20Gbps signaling rate port (charge supports up to

5V/3A)

Rear 3 High-speed USB 480Mbps signaling rate port; 3 Type-A SuperSpeed USB

5Gbps signaling rate port;

Flex I/O option:

1 SuperSpeed USB Type-C<sup>®</sup> 10Gbps signaling rate (Power Delivery 15W, Alt Mode DisplayPort); 1 Dual SuperSpeed USB Type-A 5Gbps signaling

rate

Internal 1 High-speed USB 480Mbps signaling rate header for SD Card Reader

**HD Integrated Audio** 

Connector(s)

Flash ROM Yes
CPU Fan Header Yes
Memory Fan Header None

**Chassis Fan Header** 1 Rear System Chassis Fan Header, 1 Graphic chassis Fan Header.

Front PCI Fan Header None
Front Control Yes
Panel/Speaker Header

Yes

Realtek ALC3252

CMOS Battery Holder -Lithium

**Integrated Trusted** 

**Platform Module** 

Integrated TPM 2.0 (Infineon SLB9672)

Convertible to FIPS 140-2 Certified mode through firmware v15.21

MP)

### **System Technical Specifications**

**Power Supply Headers** Yes

Power Switch, Power LED Yes & Hard Drive LED Header

**Clear Password Jumper** None

**Keyboard/Mouse** USB or PS/2 Mouse (option)

260W EPA92, 450W EPA90 and 550W EPA92 **Power Supply** 

<sup>1</sup>Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 10 Professional 64 bit, Red Hat Linux

64-bit. 32-bit Windows Operating Systems support up to 4 GB.

<sup>2</sup>M.2 storage supports compatible devices up to 80mm

### **System Configurations**

HP Z2 G9 SFF Workstation Processor Info Desktop PC Configuration #1

Core i5-12500,6C 3.0G 65W **Memory Info** 2 x 8G DDR5 4800 UDIMM NECC

**Graphics Info** 

**NVIDIA T400 4GB** 

Disks/Optical/Floppy 512GB SSD Z Turbo PSU 260W

**Other** NA

**Energy Consumption** (Watts)

	115	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	16.	907	16.195		16.452		
Windows short Idle (S0)	17.	17.323		17.742		17.245	
Windows Busy Typ(S0)	165.717		168.913		164.628		
Windows Busy Max (S0)	187	.903	183.393		186.965		
Sleep (S3)	1.001	0.991	1.033	1.001	0.991	1.033	
Off (S5)	0.657	0.631	0.672	0.657	0.631	0.672	
Zero Power Mode (ErP)	0.229		0.237		0.224		

**Heat Dissipation** (Btu/hr)

	115	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Enabled	LAN Enabled	
Windows long Idle (S0)	57.	687	55.257		56.134		
Windows short Idle (S0)	59.	59.106		60.536		58.84	
Windows Busy Typ(S0)	565.426		576.331		561.711		
Windows Busy Max (S0)	641	.125	625.737		637.925		
Sleep (S3)	3.415	3.381	3.525	3.415	3.381	3.525	
Off (S5)	2.242	2.153	2.293	2.242	2.153	2.293	
Zero Power Mode (ErP)	0.781		0.809		0.764		

HP Z2 G9 SFF Workstation Processor Info Desktop PC Configuration #2

Core i7-12700,12C 2.1G 65W **Memory Info** 2 x 8G DDR5 4800 UDIMM NECC

**Graphics Info NVIDIA T1000 8GB** Disks/Optical/Floppy 512GB SSD Z Turbo

PSU 450W **Other** NA

**Energy Consumption** 

	115 VAC		230 VAC		TOO VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows long Idle (S0)	19.136		19.335		19.211	

220 1/00



(Watts)

11E V/AC

100 1/00

## **System Technical Specifications**

Windows short Idle (S0)	20.404		21.197		20.32	
Windows Busy Typ(S0)	245.533		239.257		242.62	
Windows Busy Max (S0)	268.903		247.683		266.482	
Sleep (S3)	1.132	1.101	1.211	1.132	1.101	1.211
Off (S5)	0.735	0.722	0.744	0.735	0.722	0.744
Zero Power Mode (ErP)	0.265		0.268		0.252	

Heat Dissipation (Btu/hr)

	115 VAC		230	230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Enabled	LAN Enabled	LAN Enabled	
Windows long Idle (S0)	65.	292	65.971		65.	65.548	
Windows short Idle (S0)	69.618		72.324		69.332		
Windows Busy Typ(S0)	837.759		816.345		827.819		
Windows Busy Max (S0)	917	.497	845.094		909.237		
Sleep (S3)	3.862	3.757	4.132	3.862	3.757	4.132	
Off (S5)	2.508	2.463	2.539	2.508	2.463	2.539	
Zero Power Mode (ErP)	0.904		0.914		0.86		

HP Z2 G9 SFF Workstation Processor Info
Desktop PC Configuration Memory Info
#3 Graphics Info

 Processor Info
 Core i7-12700K,12C 3.6G 125W

 Memory Info
 2 x 16G DDR5 4800 UDIMM ECC

**Graphics Info** NVIDIA RTX A2000 **Disks/Optical/Floppy** 512GB SSD Z Turbo

PSU 450W Other NA

Energy Consumption (Watts)

	115	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	21.	043	20.428		20.	20.228	
Windows short Idle (S0)	23.	125	22.638		22.444		
Windows Busy Typ(S0)	258.063		253.127		256.521		
Windows Busy Max (S0)	274	1.25	263.977		268.45		
Sleep (S3)	1.302	1.221	1.411	1.302	1.221	1.411	
Off (S5)	0.705	0.691	0.725	0.705	0.691	0.725	
Zero Power Mode (ErP)	0.238		0.242		0.239		

Heat Dissipation (Btu/hr)

	115 VAC		230	230 VAC		VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	71.	799	69.700		69.018		
Windows short Idle (S0)	78.	78.903		77.241		76.579	
Windows Busy Typ(S0)	880.511		863.669		875.25		
Windows Busy Max (S0)	935	.741	900.69		915.951		
Sleep (S3)	4.442	4.166	4.814	4.442	4.166	4.814	
Off (S5)	2.405	2.358	2.474	2.405	2.358	2.474	
Zero Power Mode (ErP)	0.812		0.826		0.815		

HP Z2 G9 SFF Workstation Processor Info
Desktop PC Configuration
#4 Graphics Info

 Processor Info
 Core i7-12700K,12C 3.6G 125W

 Memory Info
 4 x 16G DDR5 4800 UDIMM NECC

**Graphics Info** NVIDIA RTX A2000 **Disks/Optical/Floppy** 1T SSD Z Turbo

PSU 550W

## **System Technical Specifications**

	Other	NA					
Energy Consumption		115	VAC	230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	16.118		16.525		16.022	
	Windows short Idle (S0)	17.591		17.935		17.485	
	Windows Busy Typ(S0)	166.23		166.157		165.652	
	Windows Busy Max (S0)	21	5.6	214.207		213.633	
	Sleep (S3)	1.023	0.968	1.215	1.023	0.968	1.215
	Off (S5)	0.654	0.642	0.678	0.654	0.642	0.678
	Zero Power Mode (ErP)	0.248		0.252		0.248	

Heat Dissipation (Btu/hr)

	115 VAC		230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	54.	995	56.383		54.	54.667	
Windows short Idle (S0)	60.020		61.194		59.659		
Windows Busy Typ(S0)	567	.177	566.928		565.205		
Windows Busy Max (S0)	735	.627	730.874		728.916		
Sleep (S3)	3.491	3.303	4.146	3.491	3.303	4.146	
Off (S5)	2.231	2.191	2.313	2.231	2.191	2.313	
Zero Power Mode (ErP)	0.846		0.86		0.846		

HP Z2 G9 SFF Workstation

Desktop PC Configuration

#5

Processor Info

Memory Info

Graphics Info

 Processor Info
 Core i9-12900K,16C 3.2G 125W

 Memory Info
 4 x 32G DDR5 4800 UDIMM ECC

Graphics Info NVIDIA RTX A4000
Disks/Optical/Floppy 1T SSD Z Turbo

PSU 550W Other NA

Energy Consumption (Watts)

	115	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	32.	725	32.709		32.711		
Windows short Idle (S0)	33.525		35.083		33.432		
Windows Busy Typ(S0)	392	.633	392.11		390.621		
Windows Busy Max (S0)	419	.361	406.324		414.845		
Sleep (S3)	1.929	1.862	2.142	1.929	1.862	2.142	
Off (S5)	0.776	0.749	0.825	0.776	0.749	0.825	
Zero Power Mode (ErP)	0.213		0.219		0.208		

Heat Dissipation (Btu/hr)

	115	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows long Idle (S0)	111	.658	111.603		111.61		
Windows short Idle (S0)	114	.387	119	.703	114.07		
Windows Busy Typ(S0)	1339	9.664	1337.879		1332.799		
Windows Busy Max (S0)	143	0.86	1386.377		1415.451		
Sleep (S3)	6.582	6.353	7.309	6.582	6.353	7.309	
Off (S5)	2.648	2.556	2.815	2.648	2.556	2.815	
Zero Power Mode (ErP)	0.727		0.747		0.71		

**NOTE:** The Power Supply Efficiency report may be found at the following links: https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2



# **System Technical Specifications**

## **Declared Noise Emissions**

System Configuration (Entry level, Lowprofile)	Processor Info	Intel® CPU Core i5-12400 6C LGA 2.500	G 18 MB 65W (Intel - Alder Lake-S)	
	Memory Info	1* 32GB 4800 SK hynix memory		
	Graphics Info	Intel® UHD		
	Disks/Optical/Floppy	1*2TB Samsung M.2		
	Power Supply	LITE-ON 450W		
<b>Declared Noise Emissions</b> (in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)	
7779 and ISO 9296)	Idle	3.1	15.2	
	Hard drive Operating (Drive Random Seek)	3.4	23.9	
	Hard drive Operating (Active mode)	3.05	14.8	
System Configuration (Mid-level, Lowprofile)	Processor Info	Intel® CPU Core i9-12900 16C LGA 2.40G 30 MB 65W ECC (Intel - Alder Lake-S)		
	Memory Info	4* 32GB 4800 SK hynix memory		
	Graphics Info	NVIDIA® T1000		
	Disks/Optical/Floppy	2*WD 2TB 7200RPM SATA HDD; 3*2TB Samsung M.2		
	Power Supply	LITE-ON 450W		
<b>Declared Noise Emissions</b> (in accordance with ISO		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)	
7779 and ISO 9296)	Idle	3.35	23.4	
	Hard drive Operating (Drive Random Seek)	3.48	24.9	
	Hard drive Operating (Active mode)	4.34	30.5	
System Configuration (High-end, Lowprofile)	Processor Info	Intel® Core i9-12900K 16C 3.20G LGA 30 MB 125W ECC (Intel - Alder Lake-S)		
	Memory Info	4* 32GB 4800 SK hynix memory		
	Graphics Info	NVIDIA® T1000		
	Disks/Optical/Floppy	2*WD 2TB 7200RPM SATA HDD; 3*2TB Samsung M.2		
	Power Supply	LITE-ON 450W		
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)	
	Idle	3.37	23.1	
	Hard drive Operating (Drive Random Seek)	3.45	24.7	
	Hard drive Operating (Active mode)	4.35	33.0	
System Configuration	Processor Info	Intel® Core i5-12400 6C LGA 2.50G 18	MB 65W (Intel - Alder Lake-S)	
(Entry level, Riser)	Memory Info	1* 32GB 4800 SK hynix memory		
	Graphics Info	Intel® UHD		



# **System Technical Specifications**

	Disks/Optical/Floppy	1*2TB Samsung M.2			
	Power Supply	Liteon 550W EPA92			
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)		
	Idle	3.01	12.0		
	Hard drive Operating (Drive Random Seek)	3.37	23.1		
	Hard drive Operating (Active mode)	3.09	15.5		
System Configuration (Mid-level, Riser)	Processor Info	Intel® CPU Core i9-12900 16C LGA 2.40G 30 MB 65W ECC (Intel - Alder Lake-S)			
	Memory Info	4* 32GB 4800 SK hynix memory	4* 32GB 4800 SK hynix memory		
	Graphics Info	NVIDIA® GeForce RTX 3070	NVIDIA® GeForce RTX 3070		
	Disks/Optical/Floppy	1*WD 2TB 7200RPM SATA HDD; 3*2TB Samsung M.2			
	Power Supply	Liteon 550W EPA92			
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		Sound Power (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)		
	Idle	3.41	24.4		
	Hard drive Operating (Drive Random Seek)	3.45	24.6		
	Hard drive Operating (Active mode)	4.68	36.4		
System Configuration (High-end, Riser)	Processor Info	Intel® Core i9-12900K 16C 3.20G LGA 30 MB 125W ECC (Intel - Alder Lake-S)			
	Memory Info	4* 32GB 4800 SK hynix memory			
	Graphics Info	NVIDIA® GeForce RTX 3070			
	Disks/Optical/Floppy	1*WD 2TB 7200RPM SATA HDD; 3*2TB Samsung M.2			
	Power Supply	Liteon 550W EPA92			
<b>Declared Noise Emissions</b> (in accordance with ISO 7779 and ISO 9296)		<b>Sound Power</b> (LWAd, bels)	<b>Deskside Sound Pressure</b> (LpAm, decibels)		
	Idle	3.40	22.9		
	Hard drive Operating (Drive Random Seek)	3.47	26.2		
	Hard drive Operating (Active mode)	4.66	37.3		



### System Technical Specifications

Environmental Requirements

**Temperature** Operating: 5° to 35° C (40° to 95° F)

Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

**Humidity** Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Cooling for details.

**Dynamic** Shock

Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g)

square: 422 cm/s, 20g

Vibration

Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g<sup>2</sup>/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g<sup>2</sup>/Hz

**Cooling** Above 1524 m (5,000 feet) altitude, the maximum operating temperature

is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation,

up to 3048 m (10,000 feet)

### System Technical Specifications

### **Physical Security and Serviceability**

**Access Panel** Tool-less

Includes support information

**Optical Drive** Tool-less, except for Screw-In carrier **Hard Drives** Tool-less, except for internal/external bay

**Expansion Cards** Tool-less

**Processor Socket** Tool-less, except for the processor heatsink

**Blue User Touch Points** Yes, on tool-less internal chassis mechanisms

Color-coordinated Cables Yes

and Connectors

Memory Tool-less

**System Board** Screw-In

**Padlock Support** Yes (optional): Locks side cover and secures chassis from theft

0.22-in diameter padlock loop at rear of system

Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft **Cable Lock Support** 

3 mm x 7 mm slot at rear of system

**Universal Chassis Clamp** 

**Lock Support** 

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows

multiple units to be chained together when used with optional cable

Threaded feature at rear of system

**Solenoid Lock and Hood** 

Sensor

Yes (optional)

The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through

software and a password. You can also lock and unlock the chassis remotely over the network. The

Sensor Kit detects when the access panel has been removed.

Keyboard/Mouse/Video

**Cable Lock** 

No

**CPUs and Heatsinks** A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be

removed. CPU removal is tool-less

**Internal Speaker** Yes

**Power Supply Fans** 70mm x 70mm x 25mm 4-wire PWM (non-serviceable)

**Access Panel Key Lock** 

Nο

**Integrated Chassis** 

No

Handles

Requires T15 Torx or flat blade screwdriver **Power Supply PCI Card Retention** Yes, rear (all), middle (optional), front (none)

# Service, Support, and Warranty

On-site Warranty and Service<sup>1</sup>: Three-years, limited warranty and service offering delivers on-site, next business-day<sup>2</sup> service for parts and labor and includes free telephone support<sup>3</sup> 8am - 5pm. Global coverage<sup>2</sup> ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty.



## **System Technical Specifications**

**NOTE 1:** Terms and conditions may vary by country. Certain restrictions and exclusions apply.

**NOTE 2:** On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

**NOTE 3:** Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at:

http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.



### **System Technical Specifications**

#### BIOS

**BIOS 64-bit Services** 

BIOS supports 64-bit Operating systems only.

BIOS Boot Specification v1.01.(Not Support)

**PCI 3.0 Support** 

Full BIOS support for PCI Express through industry standard interfaces.

**ATAPI** BBS

ATAPI Removable Media Device BIOS Specification Version 1.0.

**WMI Support** 

WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM)

and WBEM specifications.

BIOS Boot Spec 1.01+

Provides more control over how and from what devices the workstation will boot.

**BIOS Power On ROM Based Computer**  Users can define a specific date and time for the system to power on.

Setup Utility (F10) System/Emergency ROM Review and customize system configuration settings controlled by the BIOS.

Flash Recovery with Video

Recovers system BIOS in corrupted Flash ROM.

Replicated Setup

**SMBIOS** 

Saves BIOS settings to USB flash device in human readable file (HpSetup.txt).

BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed

without entering Computer Configuration Utility (F10 Setup). System Management BIOS Reference Specification, Version 3.4

External BIOS simulator found at: http://csrsml.itcs.hp.com/

**Boot Control Memory Change Alert** 

**Thermal Alert** 

Disables the ability to boot from removable media on supported devices.

Alerts management console if memory is removed or changed.

Monitors the temperature state within the chassis. Three modes:

NORMAL - normal temperature ranges.

ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid

shutdown or provide for a smoother system shutdown.

• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer

without warning before hardware component damage occurs.

Remote ROM Flash **ACPI (Advanced** 

Provides secure, fail-safe ROM image management from a central network console.

Allows the system to enter and resume from low power modes (sleep states).

Management Interface)

Configuration and Power Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without

affecting other elements of the system.

Supports ACPI 6.0 for full compatibility with 64-bit operating systems.

**Ownership Tag** Remote Wakeup/Remote A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.

Shutdown

**Instantly Available PC** (Suspend to RAM - ACPI sleep state S3)

System administrators can power on, restart, and power off a client computer from a remote location.

**Remote System** 

Allows for very low power consumption with quick resume time.

Installation via F12 (PXE 2.1) (Remote Boot from

Allows a new or existing system to boot over the network and download software, including the operating system.

**ROM revision levels** 

Server)

Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW

applications can use and report this information.

System board revision level

Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.

**Start-up Diagnostics** (Power-on Self-Test)

Assesses system health at boot time with selectable levels of testing.

### System Technical Specifications

Auto Setup when new

hardware installed System automatically detects addition of new hardware.

**Keyboard-less Operation** The system can be booted without a keyboard.

**Localized ROM Setup** Common BIOS image supports System Configuration Utility (F10 Setup) menus in 14 languages with

local keyboard mappings.

The user or MIS to set a unique tag string in non-volatile memory. **Asset Tag** 

Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually. Per-slot Control **Adaptive Cooling** Control parameters are set according to detected hardware configuration for optimal acoustics.

(Pre-video) critical errors are reported via beeps and blinks on the power LED.

**Pre-boot Diagnostics** 

Revision

**UEFI Specification** 

2.7

**ACPI** Advanced Configuration and Power Management Interface, Version 6.0 ATA (IDE) AT Attachment 6 with Packet Interface (ATA/ATAPI-6). Revision 3b **CD Boot** "El Torito" Bootable CD-ROM Format Specification Version 1.0

**EDD** Enhanced Disk Drive Specification Version 1.1

BIOS Enhanced Disk Drive Specification Version 3.0(Not support)

**EHCI** Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0

PCI Local Bus Specification, Revision 2.3 PCI

> PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7

PCI Express Base Specification, Revision 2.0 **PCI Express** 

PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0

POST Memory Manager Specification, Version 1.01 (Not support) **PMM** 

**SATA** Serial ATA Specification, Revision 1.0a

> Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0

SPD JEDEC JESD300-5

**TPM** Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9670).

Common Criteria EAL4+ certified.

FIPS 140-2 Certification TCG TPM Certified products list:

http://www.trustedcomputinggroup.org/certification/tpm-certified-products/

Universal Host Controller Interface Design Guide, Revision 1.1 UHCI

Universal Serial Bus Revision 1.1 Specification **USB** 

Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification

System Management BIOS Reference Specification, Version 3.2 **SMBIOS** 

External BIOS simulator found at: http://csrsml.itcs.hp.com/

# Social and Environmental Responsibility

& Declarations

**Eco-Label Certifications** This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT<sup>®</sup> Gold registered in the United States. See http://www.epeat.net for registration status in your country.
- TCO Certified
- China Energy Conservation Program (CECP)



### **System Technical Specifications**

- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label\*

# Sustainable Impact Specifications

- Ocean-bound plastic in System FAN, CPU FAN and Speaker
- 45% post-consumer recycled plastic
- Low halogen
- Outside Box and corrugated cushions are 100% sustainably sourced and recyclable
- Molded Paper Pulp Cushion inside box is 100% sustainably sourced and recyclable
- Bulk packaging available

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

#### Energy Consumption (in accordance with US ENERGY STAR® test method)

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Sort idle)	45.62 W	45.60 W	45.63 W
Normal Operation (Long idle)	41.46 W	41.62 W	41.57 W
Sleep	2.34 W	2.34 W	2.39 W
Off	0.89 W	0.91 W	0.90 W

#### Note:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz
Normal Operation (Short idle)	156 BTU/hr	156 BTU/hr	156.1 BTU/hr
Normal Operation (Long idle)	141.8 BTU/hr	142.3 BTU/hr	142.2 BTU/hr
Sleep	8 BTU/hr	8 BTU/hr	8.2 BTU/hr
Off	3 BTU/hr	3.1 BTU/hr	3.1 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

# Declared Noise

Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L <sub>WAd</sub> , bels)	Sound Pressure (L <sub>PAm</sub> , decibels)
Typically Configured — Idle	3.37	23.1
Fixed Disk – Random writes	3.45	24.7
Optical Drive – Sequential reads	4.35	33.0



### System Technical Specifications

#### **Longevity and Upgrading**

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### **Batteries**

This battery in this product complies with EU Directive 2006/66/EC

Battery size: CR2032 (coin cell) Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40 ppm by weight

#### **Additional Information**

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and IS01043.
- This product is 93.5% recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

**External:** PAPER/Corrugated 1204 q PAPER/Molded Pulp 722 q **Internal:** PLASTIC/Polyethylene low 40 g

density - LDPE

The plastic packaging material contains at least 0.0% recycled content.

The corrugated paper packaging materials contains at least 35% recycled content.

#### **RoHS Compliance**

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

### System Technical Specifications

#### **Material Usage**

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen\_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

### End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These



### **System Technical Specifications**

instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP, Inc. Corporate Environmental Information For more information about HP's commitment to the environment:

**Global Citizenship Report** 

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label certifications** 

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf

footnotes

- Percentage of ocean-bound plastic contained in each component varies by product
- Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.
- External power supplies, WWAN modules, power cords, cables and peripherals excluded.
- 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
- Fiber cushions made from 100% recycled wood fiber and organic materials.

## **Technical Specifications - Processors**

### 12<sup>th</sup> Generation Intel® Core™ Processors

Intel® Core™ i9-12900K Processor

Intel<sup>®</sup> Core<sup>™</sup> i9-12900 Processor

Intel® Core™ i7-12700K Processor

Intel® Core™ i7-12700 Processor

Intel® Core™ i5-12600K Processor

Intel<sup>®</sup> Core<sup>™</sup> i5-12600 processor

Intel® Core™ i5-12500 processor

Intel<sup>®</sup> Core<sup>™</sup> i5-12400 processor

Intel<sup>®</sup> Core™ i3-12300 processor

Intel® Core™ i3-12100 processor



### **Technical Specifications - Hard Drives**

SATA	Hard	Drives	for	HP
Workstations				

500GB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 500GB
Protocol SATA
Form Factor 3.5"
Controller AHCI

**Height** 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Up to 600MB/s \*

**Physical Size** 4 in; 10.17 cm

2 ms \*

11 ms \*

21 ms \*

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

**Buffer** 

32MB

Seek Time (typical reads, includes controller Average

overhead, including settling)

Full Stroke

Rotational Speed 7,200 rpm Logical Blocks 976,773,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB SATA 7200	rpm
6Gb/s 3.5" HDD	

Capacity	1TB
Protocol	SATA
Form Factor	3.5"
Controller	AHCI
Height	1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Up to 600 MB/s \*

Synchronous Transfer

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, includes controller overhead, including settling)

Single Track 2 ms \*

Average 11 ms \*

Full Stroke 21 ms \*

Rotational Speed 7,200 rpm
Logical Blocks 1,953,525,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

2TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity2TBProtocolSATAForm Factor3.5"ControllerAHCI



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

**Annualized Failure Rate** 

(based on Rated POH) < 0.62% Height 1 in; 2.54 cm

Width **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in: 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

**Synchronous Transfer** 

Rate (Maximum)

Up to 600MB/s \*

Buffer 64MB

Seek Time (typical reads, **Single Track** 2.0 ms \* includes controller Average 11 ms \* overhead, including **Full Stroke** 21 ms \* settling)

**Rotational Speed** 7,200 rpm **Logical Blocks** 3,907,029,168

**Operating Temperature** 41° to 131° F (5° to 55° C)

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

Capacity 1TB Height 1 in; 2.54 cm **Protocol** SATA **Form Factor** 3.5" **Controller AHCI** Reliability 2.0M hours **Rated Power On Hours** 8760/vr

**Annualized Failure Rate** 

(based on Rated POH) <0.62%

Width **Media Diameter** 3.5 in: 8.9 cm **Physical Size** 4 in; 10.17 cm

Up to 600MB/s \*

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

**Synchronous Transfer** 

Rate (Maximum)

128MB

Seek Time (typical reads. **Single Track** 0.32ms\* includes controller **Average** 7.45ms\* overhead, including

settling)

**Buffer** 

7,200 rpm

**Full Stroke** 

14.2ms\*

**Rotational Speed** 

**Operating Temperature** 41° to 140° F (5° to 60° C)

**Performance Sequential Read** up to 226MB/s\* **Sequential Write** up to 226MB/s\*

**Enterprise Class Features** High Reliability

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

> Capacity 2TB



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

**Protocol** SATA **Form Factor** 3.5" **Controller AHCI** Reliability (MTBF) 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** < 0.62%

(based on Rated POH) Rated for 24/7/365

Operation

Physical Size (Height) 1 in; 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in: 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

**Synchronous Transfer** Up to 600MB/s\* Rate (Maximum)

128MB

Seek Time (typical reads, **Single Track** 0.7ms\* includes controller Average 8.5ms\* overhead, including **Full Stroke** 15.7ms\* settling)

**Rotational Speed** 7,200 rpm

**Operating Temperature** 41° to 131° F (5° to 55° C)

**Performance Sequential Read** up to 226MB/s\*

**Sequential Write** up to 226MB/s\*

**Enterprise Class Features** High Reliability

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

2TB SATA 7200 rpm

6Gb/s 3.5" HDD

(Enterprise Class)

Capacity 4TB SATA Protocol 3.5" Form Factor Controller AHCI Reliability 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** <0.62%

(based on Rated POH) Rated for 24/7/365

Operation

Physical Size (Height) 1 in; 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in; 8.9 cm **Physical Size** 4 in; 10.17 cm

Interface Serial ATA (6Gb/s), NCQ enabled

**Synchronous Transfer** Up to 600MB/s\*

Rate (Maximum)

**Buffer** 256MB



<sup>\*</sup>Actual performance may vary.

Seek Time (typical reads, includes controller overhead, including settling)

Single Track 0.7ms\*

Average 8.5ms\*

Full Stroke 15.7ms\*

**Rotational Speed** 7,200 rpm

**Operating Temperature** 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s\*
Sequential Write up to 226MB/s\*

**Enterprise Class Features** High Reliability

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

8TB SATA 7200 rpm
6Gb/s 3.5" HDD
(Enterprise Class)

Capacity	8TB	
Protocol	SATA	
Form Factor	3.5"	
Controller	AHCI	
Reliability	2.0M hours	

WidthMedia Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.17 cm

Up to 600MB/s [1]

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer

Rate (Maximum)

**Buffer** 

256MB

Seek Time (typical reads,<br/>includes controller<br/>overhead, including<br/>settling)Single Track<br/>Average<br/>Full Stroke0.7ms\*<br/>8.5ms\*<br/>15.7ms\*

**Rotational Speed** 7,200 rpm

**Operating Temperature** 41° to 140° F (5° to 60° C)

Performance Sequential Read up to 226MB/s<sup>1</sup>
Sequential Write up to 226MB/s<sup>1</sup>

**Enterprise Class Features** High Reliability

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

500GB SATA	7.2K SED
2.5" HDD	

Capacity	500GB
Protocol	SATA
Form Factor	2.5"

**Height** 0.275 in; 0.7 cm

Width Media Diameter 2.5 in; 6.36 cm
Physical Size 2.75 in; 6.99 cm

Up to 600MB/s\*

Interface Serial ATA (6.0Gb/s), NCQ enabled

**Synchronous Transfer** 

Rate (Maximum)

Buffer 64MB

Single Track 1ms\*



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

25ms (Typical)\*

#### **Technical Specifications - Hard Drives**

Seek Time (typical reads, Average 4.2ms\*

**Full Stroke** 

includes controller overhead, including

settling)

**Rotational Speed** 7,200 rpm

**Operating Temperature** 32° to 131° F (0° to 60° C)

**Self-Encrypting Drive** Yes

Support

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 Capacity 512GB TLC PCIe SSD Protocol (Z2G9) \_ \_ \_

Capacity512GBProtocolPCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 150TBW (TB Written)

Reliability (MTBF) 1.5M hours

**Interface** PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

**Performance Sequential Read** 6400MB/s\*

Sequential Write 3400MB/s\*
Random Read 600K IOPS\*
Random Write 600K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 Capacity
1TB TLC PCIe SSD (Z2G9) Protocol

Capacity 1TB
Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 300TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 178° F (0° to 81° C)

**Performance** Sequential Read 6500MB/s\*

Sequential Write 5000MB/s\*
Random Read 800K IOPS\*
Random Write 800K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Capacity 2TB



<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

**Protocol** PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

**Endurance** 600TBW (TB Written)

HP Z Turbo Drv PCIE-4X4 Reliability 2TB TLC PCIe SSD (Z2G9) Interface

Interface PCI Express 4.0 x4 electrical

**Operating Temperature** 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s\*
Sequential Write 5000MB/s\*
Random Read 800K IOPS\*
Random Write 800K IOPS\*

1.5M Hours

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE-4X4 Capacity

4TB

**TLC PCIe SSD** 

Capacity 4TB
Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 1200TBW (TB Written)

**Reliability** (MTBF) 1.5M Hours

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 178° F (0° to 81° C)

**Performance Sequential Read** 6500MB/s\*

Sequential Write 5000MB/s\*
Random Read 700K IOPS\*
Random Write 700K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drv PCIE Gen4x4 4TB

TLC PCIe SED OPAL2

Capacity 4TB Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 1200TBW (TB Written)
Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s\*

Sequential Write 5000MB/s\*
Random Read 700K IOPS\*
Random Write 700K IOPS\*

<sup>\*</sup>Actual performance may vary.

<sup>\*</sup>Actual performance may vary.

**Self-Encrypting Drive** Support

OPAL2

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

**HP Z Turbo Drv 512GB TLC PCIe SED OPAL2 (Z2G9)** 

512GB Capacity **Protocol** PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe **NAND Type** 3D TLC

**Endurance** 150TBW (TB Written)

Reliability 1.5M Hours

PCI Express 4.0 x4 electrical Interface **Operating Temperature** 32° to 178° F (0° to 81° C)

**Performance Sequential Read** 6400MB/s\*

> Sequential Write 3400MB/s\* **Random Read 600K IOPS\* Random Write 600K IOPS\***

**Self-Encrypting Drive** OPAL2

Support

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

<b>HP Z Turbo Drv 1TB</b>
TLC PCIe SED
OPAL2 (Z2G9)

Capacity 1TB **Protocol** PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe **NAND Type** 3D TLC

**Endurance** 300TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical **Operating Temperature** 32° to 178° F (0° to 81° C)

**Performance Sequential Read** 6500MB/s\*

Sequential Write 5000MB/s\* **Random Read** 800K IOPS\* **Random Write** 800K IOPS\*

**Self-Encrypting Drive** OPAL2

Support

#### \*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

**HP Z Turbo Drv 2TB TLC PCIe SED OPAL2 (Z2G9)** 

Capacity 2TB **PCIe Protocol** 

**Form Factor** M.2 in native Slot on motherboard

<sup>\*</sup>Actual performance may vary.

Controller NVMe NAND Type 3D TLC

**Endurance** 600TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 178° F (0° to 81° C)

Performance Sequential Read 6500MB/s\*

Sequential Write 5000MB/s\*
Random Read 800K IOPS\*
Random Write 800K IOPS\*

Self-Encrypting Drive OPAL2

Support

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

256GB 2280 PCIe-4x4 Value M.2 SSD Capacity 256GB Protocol PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe
NAND Type 3D TLC

**Endurance** 200TBW (TB Written)

Reliability 1.5M Hours

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

**Performance** Sequential Read 3100MB/s\*

Sequential Write 1400MB/s\*
Random Read 200K IOPS\*
Random Write 400K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

512GB 2280 PCIe-4x4 Value M.2 SSD **Capacity** 512GB **Protocol** PCIe

**Form Factor** M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 300TBW (TB Written)

**Reliability** 1.5M Hours

Interface PCI Express 4.0 x4 electrical Operating Temperature 32° to 158° F (0° to 70° C)

**Performance** Sequential Read 3400MB/s\*

Sequential Write 2500MB/s\*
Random Read 380K IOPS\*
Random Write 430K IOPS\*



<sup>\*</sup>Actual performance may vary.

#### **Technical Specifications - Hard Drives**

\*Actual performance may vary.

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

1TB 2280 PCIe-4x4 ValueCapacity1TBM.2 SSDProtocolPCIe

Form Factor M.2 in native Slot on motherboard

Controller NVMe NAND Type 3D TLC

**Endurance** 400TBW (TB Written)

**Reliability** 1.5M Hours

Interface PCI Express 4.0 x4 electrical
Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3400MB/s\*

Sequential Write2500MB/s\*Random Read500K IOPS\*Random Write440K IOPS\*

**NOTE:** For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.



<sup>\*</sup>Actual performance may vary.

#### **Technical Specifications - Graphics**

AMD Radeon™ Pro W6600 8GB Graphics **Form Factor** Single slot, full-height, 9.5" length

Graphics Controller Navi23 architecture
Power: 122 Watts

Cooling Solution: Active Fan Heatsink

Bus Type PCI Express 4.0 x8

Memory 8GB GDDR6 Memory
Memory Bandwidth: 224 GB/s

Memory Interface: 128 bit

**Connectors** 4x DisplayPort™ 1.4 with DSC

- HDR Ready

- Supports Multi-Stream Transport (MST)

Max simultaneous

displays

@ 60Hz with HDR Enabled 4x @ 3840x2160px (4K) 4x @ 5120x2880px (5K) 1x @ 7680x4320px (8K)

Shading Architecture Dir

**Supported Graphics APIs** 

DirectX 12 Shader Model 6.5

DirectX®12 Ultimate OpenGL® 4.6

OpenCL™ 2.1 Vulkan™ 1.2

Available Graphics

**Drivers** 

Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® T400 2GB Graphics Form Factor

Single Slot, Low Profile (2.7" H x 6.1" L)

**Graphics Controller** Turing architecture

Max Power: 30 Watts

Cooling Solution: Active fan heatsink

**Bus Type** PCI Express 3.0 x16 **Memory** 2GB GDDR6 Memory

Memory Bandwidth: 80 GB/s Memory Interface: 64 bit

**Connectors** 3x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous displays

- 3x 3840 x 2160 @ 120Hz - 3x 5120 x 2880 @ 60Hz

- supports Multi-Stream Transport (MST)

Shading Architecture DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2

Available Graphics

**Drivers** 

Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**NVIDIA® T400 4GB Graphics** 

**Form Factor** Single Slot, Low Profile (2.7" H x 6.1" L)

**Graphics Controller** Turing architecture

Max Power: 30 Watts

Cooling Solution: Active fan heatsink

**Bus Type** PCI Express 3.0 x16 Memory 4GB GDDR6 Memory

> Memory Bandwidth: 80 GB/s Memory Interface: 64 bit

**Connectors** 3x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous

displays - 3x 3840 x 2160 @ 120Hz

- 3x 5120 x 2880 @ 60Hz

- supports Multi-Stream Transport (MST)

**Shading Architecture** 

DirectX 12 Shader Model 5.1 Supported Graphics APIs OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2

**Available Graphics** Drivers

Windows 10 64-bit Windows 11 64-bit

Linux<sup>®</sup> 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**NVIDIA® T600 4GB** Graphics

**Form Factor** Single Slot, Low Profile (2.7" H x 6.1" L)

**Graphics Controller** Turing architecture

Max Power: 40 Watts

Cooling Solution: Active fan heatsink

**Bus Type** PCI Express 3.0 x16 Memory 4GB GDDR6 Memory

> Memory Bandwidth: 160 GB/s Memory Interface: 128 bit

Connectors 4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous

displays - 4x 5120 x 2880 @ 60Hz

- 2x 7680 x 4320 @ 60Hz

- 4x 3840 x 2160 @ 120Hz

supports Multi-Stream Transport (MST)

**Shading Architecture** 

DirectX 12 Shader Model 5.1 **Supported Graphics APIs** OpenGL 4.6

> DirectX 12 Vulkan 1.2



#### **Technical Specifications - Graphics**

API support includes:

CUDA, OpenCL 1.2

**Available Graphics** 

**Drivers** 

Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**NVIDIA® T1000 4GB** Graphics

**Form Factor** Single Slot, Low Profile (2.7" Hx

6.1" L)

**Graphics Controller** Turing architecture

Max Power: 50 Watts

Cooling Solution: Active fan heatsink

**Bus Type** PCI Express 3.0 x16 4GB GDDR6 Memory Memory

> Memory Bandwidth: 160 GB/s Memory Interface: 128 bit

**Connectors** 4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous - 4x 3840 x 2160 @ 120Hz displays

- 4x 5120 x 2880 @ 60Hz - 2x 7680 x 4320 @ 60Hz

- supports Multi-Stream Transport (MST)

**Shading Architecture** 

DirectX 12 Shader Model 5.1

**Supported Graphics APIs** OpenGL 4.6

DirectX 12 Vulkan 1.2

API support includes: CUDA, OpenCL 1.2 Windows 10 64-bit

**Available Graphics** 

**Drivers** 

Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

**NVIDIA® T1000 8GB Graphics** 

**Form Factor** Single Slot, Low Profile (2.7" Hx

6.1" L)

Turing architecture **Graphics Controller** 

Max Power: 50 Watts

Cooling Solution: Active fan heatsink

**Bus Type** PCI Express 3.0 x16 **Memory** 8GB GDDR6 Memory

> Memory Bandwidth: 160 GB/s Memory Interface: 128 bit

**Connectors** 4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous - 4x 3840 x 2160 @ 120Hz displays - 4x 5120 x 2880 @ 60Hz



- 2x 7680 x 4320 @ 60Hz

- supports Multi-Stream Transport (MST)

**Shading Architecture** 

DirectX 12 Shader Model 5.1

**Supported Graphics APIs** 

OpenGL 4.6 DirectX 12

Vulkan 1.2 API support includes: CUDA, OpenCL 1.2

**Available Graphics** 

**Drivers** 

Windows 10 64-bit Windows 11 64-bit

Linux® 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

NVIDIA® RTX™ A2000 12GB Graphics Form Factor

Low-Profile Double Slot (2.7" H x

6.1" L)

**Graphics Controller** 

Ampere architecture Power: 70 Watts

Cooling: Active Fan Heatsink

Bus Type Memory PCI Express 4.0 x16 12GB GDDR6 memory

Memory Bandwidth: 288 GB/s Memory Interface: 192 bit

Support Error-correcting code (ECC)

Connectors

4x mDP (Mini DisplayPort™) 1.4 Connectors

Max simultaneous

displays

4x 4096 x 2160 @ 120 Hz, 4x 5120 x 2880 @ 60 Hz 2x 7680 x 4320 @ 60 Hz

**Shading Architecture** 

Supported Graphics APIs OpenGL 4.6

Shader Model 6.5

DirectX 12

Vulkan 1.2

API support includes: CUDA, OpenCL 1.2

Available Graphics

**Drivers** 

Windows 10 64-bit Windows 11 64-bit

Linux<sup>®</sup> 64-bit (selected Enterprise distributions)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

HP 9.5mm Slim DVD Writer **Description** 

9.5mm height, tray-load Either horizontal or vertical

Mounting Orientation Interface Type

SATA/ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

**Supported Media Types** 

DVD+R

DVD+RW



DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

**Disc Capacity DVD-ROM** 8.5 GB DL or 4.7 GB standard

Access Times Full Stroke DVD < 200 ms (seek)

**Full Stroke CD** < 200 ms (seek)

Maximum Data Transfer CD ROM Read

Rates

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

**DVD ROM Read** DVD+RW Up to 8X

DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

**Power** Source SATA DC power receptacle

**DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

**DC Current** 5 VDC -< 800 mA typical, <1600 mA maximum

**Operating Environmental Temperature** 41° to 122° F (5° to 50° C)

(all conditions non-

condensing)

Relative Humidity
Maximum Wet Bulb

10% to 80% 84° F (29° C)

**Temperature** 

**Operating Systems** 

Supported

Windows 10, Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or Windows XP

Home 32\*. Linux®

No driver is required for this device. Native support is provided by the

operating system.

**Kit Contents** HP SATA DVD Writer drive, installation guide.

**Approvals** USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0.

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

HP 9.5mm Slim DVD-ROM Description

Drive

**Description** 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA / ATAPI
Dimensions (WxHxD) 128 x 9.5 x 127mm

**Disc Capacity DVD-ROM**Single layer: Up to 4.7 GB
Double layer: Up to 8.5 GB

**Access Times DVD-ROM Single Layer** < 110 me (typical)

> **CD-ROM Mode 1** < 110 ms (typical) **Full Stroke DVD** < 230 ms (typical) **Full Stroke CD**

< 220 ms (typical)

**Power** Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

**DC Current** 5 VDC - <800mA typical, < 1600 mA maximum

**Operating Environmental Temperature** 41° to 122° F (5° to 50° C)

(all conditions non-

condensing)

**Relative Humidity** 10% to 80% **Maximum Wet Bulb** 84° F (29° C)

**Temperature** 

**Operating Systems** Supported

Windows 10, Windows 7 Professional 32-bit and 64-bit,

Windows Vista Business 64\*, Windows Vista Business 32\*, Windows Vista Home Basic 32\*, Windows 2000, Windows XP Professional or Windows XP

Home 32\*. Linux®

No driver is required for this device. Native support is provided by the

operating system.

**Kit Contents** 9.5mm Slim DVD-ROM Drive, slim SATA data/power cable, installation

guide

**Approvals** USB-IF, WHQL, Compliant with USB Mass Storage Class Bulk only Transport

Specification Rev. 1.0,

Compliant Intel Front Panel I/O Connectivity Design Guide V. 1.3, FCC, CE,

BSMI, C-Tick, VCCI, MIC, cUL, TUVT

HP SD Media Card Reader Description USB3.0-SD4.0

NOTE: actual throughput is USB2.0.

**Interface Type** 

Support USB 2.0 LPM function

Support USB 3.0 U1/U2/U3 Power saving mode

Support USB 3.0 LTM function.

**Dimensions** (WxHxD)

Dedicated slot in front bezel (orderable option)

Supported Media Types

i. Secure Digital Card (SD)

Secure Digital Support up to 2TB

iii. Secure Digital HC (SDHC) iv. Secure Digital XC (SDXC)

Support SD USH50 mode

vi. miniSD \*1

vii. miniSDHC\*1 viii. MicroSD\*1

ix. MicroSDHC\*1

MicroSDXC\*1

Note: "\*1" means Adapter Needed

Operating Systems Supported

No driver is required for this device. Native support is provided by the operating system.



#### **Technical Specifications - Graphics**

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See <a href="http://www.microsoft.com">http://www.microsoft.com</a>.

See http://www.microsoft.com/windows/windows-7/ for details.



Integrated Intel® I219LM Connector

PCIe GbE Controller (Intel® vPro® with Intel® AMT 16.0¹) **Connector** RJ-45

Cabling Twisted pair up to 100m

**Controller** Intel® I219LM GbE platform LAN connect networking controller

Memory 3 KB Tx and 3KB Rx FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1as/1588, 802.1p, 802.1Q, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u,

802.3z

**Bus Architecture** PCI Express and SMBus

**Data Transfer Mode** PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

**Power Requirement** Requires 3.3V (integrated regulators for core Vdc)

**Boot ROM Support** Yes

**Network Transfer Mode** Full-duplex; Half-duplex

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities vPro®, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI,

Advanced cable diagnostic, loopback modes,

AMT 16.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery

(MLD)

<sup>1</sup>Requires activation and a system with a corporate network connection, an Intel® AMT enabled chipset, and network hardware and software. For notebooks, Intel AMT may be unavailable or limited over a host OS-based VPN, when connecting wirelessly, on battery power, sleeping, hibernating, or powered off. Results dependent upon hardware, setup, and configuration. For more information, visit: https://www.intel.com/content/www/us/en/architecture-and-technology/intel-active-management-technology.html

### HP 1-Port 1GbE Flex IO NIC

Connector RJ-45

Cabling 1GbE over Category 5e (or better) up to 100m

**Controller** Realtek RTL8153 **Data Rates Supported** 10/100/1000 Mbps

Compliance 802.3 (LAN)

802.3u (100BASE-TX) 802.3ab (1000BASE-T) 802.3x (Ethernet Flow Control)

802.1Q (Virtual LAN)

802.3az (Energy Efficient Ethernet)

Bus Architecture USB

**Power Requirement** Requires 3.3V (integrated regulators for core Vdc)

**Boot ROM Support** Yes

Network Transfer Mode Full-duplex; Half-duplex

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps



100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131° F (0° to 55° C)

Dimensions (HxW) 1.5 in x 1.5 in. x 0.75 in (3.81 cm x 3.81 cm x 1.9 cm)

Operating System Driver Windows 11

Support

Windows 10 Linux®

Intel® X550-T2 2-Port **10GbE NIC** 

Connector Dual-port RJ-45

Cabling 10GbE: Cat6a (or better) up to 100m

5GbE and below: Cat5e (or better) up to 100m

Controller Intel® Ethernet Controller X550 **Network Transfer Rates** 

Supported

10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE

**Data Path Width** PCIe Gen3x4

**Power Requirement** 11.2W (typical) 13.0 (Maximum)

**Operating Temperature** 32° to 131° F (0° to 55° C) **Dimensions** (HxW) 5.1 x 2.7 in (without brackets)

**Operating System Driver** Windows 11 64-Bit

Support

Windows 10 64-bit

Linux®

**Kit Contents** Intel® X550-T2 2-Port 10GbE NIC with standard height bracket

attached

 Low-profile bracket Product Literature

**NVIDIA Mellanox** ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC

Connector Dual-port SFP28

Cabling Transceiver with Multi-Mode Fiber OM3 or OM4)

Controller ConnectX-6 Dx **Network Transfer Rates** 1/10/25 GbE

Supported

**Data Path Width** PCIe Gen4x8

**Power Requirement** 19.74W Maximum power available through SFP28 port: 2.5W (each port)

**Operating Temperature** 32° to 131° F (0° to 55° C)

**Dimensions (HxW)** 6.22in. x 2.67in (158mm x 68mm)

**Operating System Driver** Windows 11 64-Bit

Windows 10 64-bit

Linux®

**Kit Contents** NVIDIA Mellanox ConnectX-6 SFP28 25GbE NIC with standard height

> bracket attached

 Low-profile bracket Product Literature

NOTE: The NVIDIA Mellanox ConnectX-6 DX network adapter requires either a PCIeG4 x4 or PCIeG4 x8 slot (electrical connection) to have full performance with two 25GbE SFP28 transceivers installed in the network adapter. When the network adapter is installed in a PCIeG3 x4 slot, the performance will

be limited when installing two 25GbE SFP28 transceivers or installing a 25GbE SFP28 transceiver plus a 10GbE SFP+ transceiver

NVIDIA Mellanox 25GbE SFP28 Transceiver Operating Temperature
Operating Humidity
Dimensions (HxWxD)

Kit Contents

32°F to 158°F (0°C to 70°C) 5% to 85%, noncondensing 0.47 x 0.54 x 2.22 inches

NVIDIA Mellanox 25GbE SFP28 Transceiver

NVIDIA Mellanox 10GbE SFP+ SR Transceiver Operating Temperature
Operating Humidity
Dimensions (HxWxD)

**Kit Contents** 

32°F to 158°F (0°C to 70°C) 5% to 85%, noncondensing 0.47 x 0.54 x 2.22 inches

NVIDIA Mellanox 10GbE SFP+ SR Transceiver

Intel® I350-T2 2-Port 1GbE NIC **Connector** 2 RJ-45

CablingCat5e (or better) up to 100mControllerIntel® Ethernet I350 Controller

Network Transfer Rates

Supported

1GbE, 100MbE, 10MbE

**Data Path Width** PCle Gen2.1x4 **Power Requirement** 4.4W (typical)

**Operating Temperature** 32° to 131° F (0° to 55° C)

2.75 x 5.5 inches (without brackets)

Operating System Driver Windows 11

**Dimensions** (HxW)

**Support** 

Windows 11 Windows 10 Linux®

**Kit Contents** 

• Intel® I350-T2 2-Port 1GbE NIC with standard height bracket attached

• Low-profile bracket

Product Literature

Intel® 1350-T4 4-Port 1GbE NIC Connector 4 RJ-45

CablingCat5e (or better) up to 100mControllerIntel® Ethernet I350 Controller

**Network Transfer Rates** 

Supported

1GbE, 100MbE, 10MbE

Data Path WidthPCle Gen2.1x4Power Requirement5W (typical)

**Operating Temperature** 32° to 131° F (0° to 55° C)

**Dimensions** (HxW) 2.75 x 5.5 inches (without brackets)

Operating System Driver Windows 11

Support

Windows 11 Windows 10 Linux®

• Intel® I350-T4 4-Port 1GbE NIC with standard height bracket attached

Low-profile bracket



Product Literature

HP Flex 1GbE Fiber LC Single Port

**Connector** Fiber

Cabling 1GbE over Category OM1 (or better) up to 100m

Controller Microchip LAN7801

Data Rates Supported 100/1000 Mbps

**Compliance** IEEE 802.1p priority encoding/tagging (QoS, CoS)

IEEE 802.1q VLAN tagging IEEE 802.3x flow control

**Bus Architecture** USB

**Power Requirement** Requires 3.3V (integrated regulators for core Vdc)

**Boot ROM Support** Yes

Network Transfer Mode Full-duplex; Half-duplex

Network Transfer Rate 100BASE-X (half-duplex) 100 Mbps

1000BASE-X (half-duplex) 1000 Mbps 1000BASE-X (full-duplex) 2000 Mbps

**Operating Temperature** 32° to 158° F (0°C to 70°C)

**calvin** 1.5 in x 1.7 in. x 0.75 in (3.84 cm x 4.3 cm x 1.9 cm)

**Operating System Driver** Windows 11 64-Bit

Support

Windows 10 64-bit

Linux®

Intel® I225-T1 1-Port 2.5GbE NIC **Connector** RJ-45

CablingCat5e (or better) up to 85mControllerIntel® Ethernet I225 ControllerNetwork Transfer Rates2.5GbE, 1GbE, 100MbE, 10MbE

**Supported** 

Data Path Width PCIe Gen3.1x1

Power Requirement 1.9W (typical)

Operating Temperature 32° to 158° F (0°C to 70°C)

**Dimensions (HxW)** 2.7 in x 2.57 in. (68.7mm x 65.3mm)

**Operating System Driver** Windows 11 64-Bit

Windows 10 64-bit

Linux®

**Kit Contents**• Intel® I225-T1 1-Port 2.5GbE NIC with standard height bracket attached

Low-profile bracket
• Product Literature

Intel® Wi-Fi 6E\* AX211 802.11ax, BT 5.2, M.2 With Internal Antenna **WLAN Standards** 802.11abgn+acR2+axR2(Pre-Standard) MIMO 2x2

High performance, low power dual band Pre-Standard-802.11ax R2 2x2,

both with 160MHz channel support - Wi-Fi 6E

Antenna 2x2 Dual- Band (internal)

**Bluetooth Standards** 5.2

**Operating Temperature** 32° to 176° F (0° to 80° C)

Interface M.2 CNVio2

#### Technical Specifications - Networking and Communications

**Dimensions** M.2 2230

**Kit Contents** 

NOTE: The AX211 with internal antenna only support WIFI 6

\*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Intel® Wi-Fi 6E\* AX211 802.11ax, BT 5.2, M.2 With External Antenna WLAN Standards 802.11abgn+acR2+axR2(Pre-Standard) MIMO 2x2

High performance, low power dual band Pre-Standard-802.11ax R2 2x2,

both with 160MHz channel support - Wi-Fi 6E

Antenna 2x2 Dual- Band (External)

**Bluetooth Standards** 5.2

**Operating Temperature** 32° to 176° F (0° to 80° C)

InterfaceM.2 CNVio2DimensionsM.2 2230

Kit Contents ANTENNA, External, Dipole, WLAN, WIFI 6E

NOTE: The AX211 with external antenna support WIFI 6E

\*Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.



#### **Summary of Changes**

Date of change:	Version History:		Description of change:
March 8, 2022	From v1 to v2	Changed	Format
March 16, 2022	From v2 to v3	Changed	Social and Environmental Responsibility section



**HP Z2 G9 SFF Workstation Desktop PC** 

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